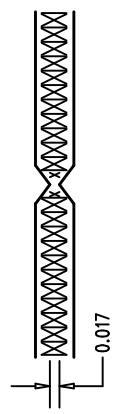


Component Side

SIZE	QTY	SYM	PLTD	TOL
15	27	+	YES	+/-0.0
125	4	X	YES	+/-0.0
72	2	□	NO	+/-0.0
35	50	◇	YES	+/-0.0
94	4	⊗	YES	+/-0.0
40	9	⊗	YES	+/-0.0
65	6	⊕	YES	+/-0.0
85	4	⊖	YES	+/-0.0

### NOTES : Unless Otherwise Specified

1. MATERIAL : FR4 OR EQUIVALENT EPOXY, 2 OZ. COPPER CLAD  
THICKNESS .062 +/--.006 TOTAL OF 4 LAYERS
2. FINISH : ALL PLATED HOLES .001 MIN. / .0015 MAX. COPPER PLATE  
ELECTRODEPOSITED TIN-LEAD COMPOSITION  
BEFORE REFLOW , SOLDER MASK OVER BARE COPPER (SMOBC)
3. SOLDER MASK : BOTH SIDES USING LPI
4. SILKSCREEN : USING WHITE NON-CONDUCTIVE EPOXY INK
5. ALL DIMENSIONS ARE IN INCHES
6. SCORING:



## Fabrication Drawing

		1630 McCarthy Blvd. Milpitas, CA 95035 PH: (408)432-1900	
Dual SIM Card Power Supply and Interface			
SIZE	A	DC709	LTC4557EUD
REV.	A		
SCALE = NONE			
SHT 1 of 1			